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Product Change Notification - JAON-17EMFE971 [\(Printer Friendly\)](#)**Date:** 27 May 2015**Notification subject:** CCB 1523 Final Notice: Qualification of palladium coated copper (PdCu) bond wire in selected products of 200K wafer technology available in 14L TSSOP package at MMT assembly site.**Notification text:** **PCN Status:**
Final notification**Microchip Parts Affected:**

See attachments of affected catalog part numbers (CPN) labeled as...

PCN_JAON-17EMFE971_Affected_CPN.xls

PCN_JAON-17EMFE971_Affected_CPN.pdf

Description of Change:

Qualification of palladium coated copper (PdCu) bond wire in selected products of 200K wafer technology available in 14L TSSOP package at MMT assembly site.

NOTE: Selected products are non-automotive devices. Please review the affected CPN lists (attached) to identify the actual parts affected.

Pre Change:

Gold wire

Post Change:

PdCu wire

Impacts to Data Sheet:

None

Reason for Change:

To improve manufacturability and qualify PdCu wire at MMT assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

June 15, 2015 (date code: 1525)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:**February 18, 2015:** Issued initial notification.**May 27, 2015:** Issued final notification. Attached the qualification report. Revised the estimated first ship date from May 20, 2015 to June 15, 2015.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): [PCN_JAON-17EMFE971_Qual_Report.pdf](#)
[PCN_JAON-17EMFE971_Affected_CPN.pdf](#)
[PCN_JAON-17EMFE971_Affected_CPN.xls](#)Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.**Terms and Conditions:**If you wish to change your product/process change notification (PCN) profile please log on to our website at <http://www.microchip.com/PCN> sign into myMICROCHIP to open the myMICROCHIP home page, then select a profile option from the left navigation bar.To opt out of future offer or information emails (other than product change notification emails), click here to go to [microchipDIRECT](#) and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."

